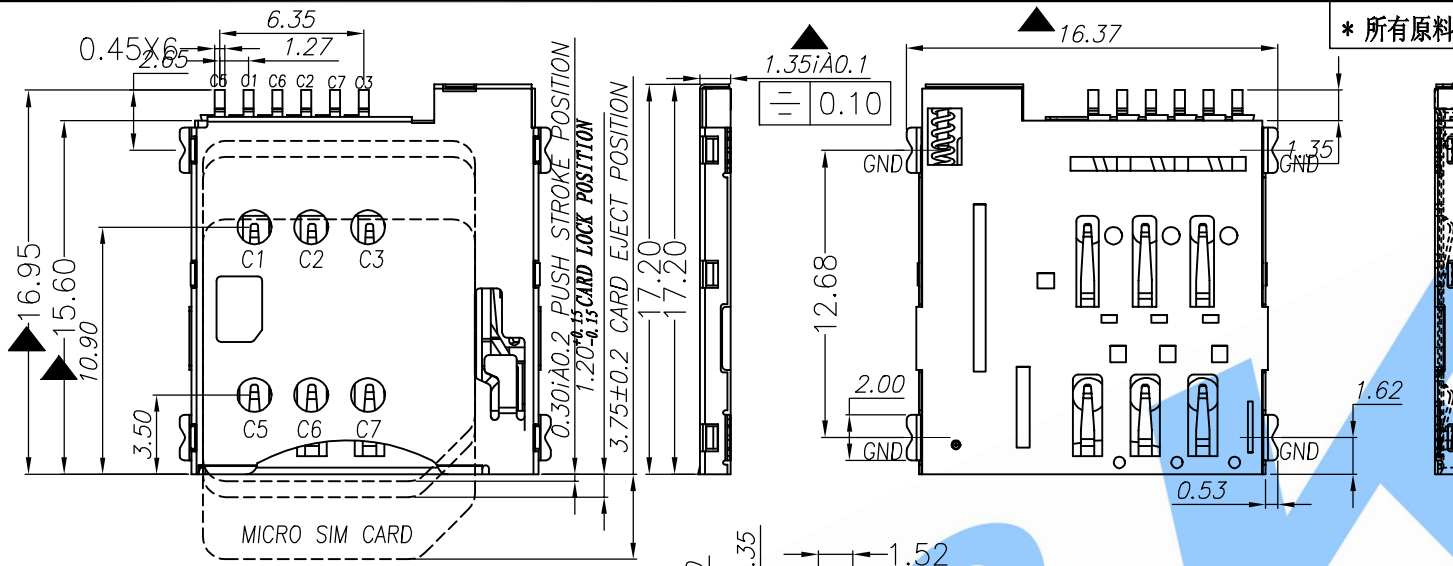
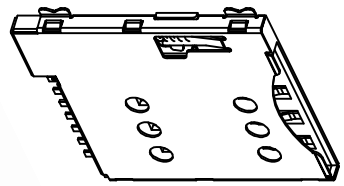
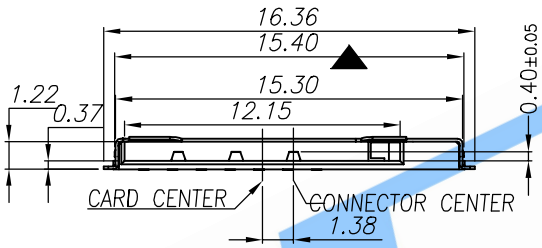
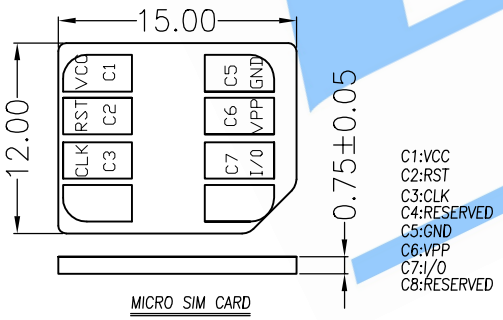
由 Autodesk 教育版产品制作

＊所有原料材质,生产制程,电镀必须符合ROHS要求

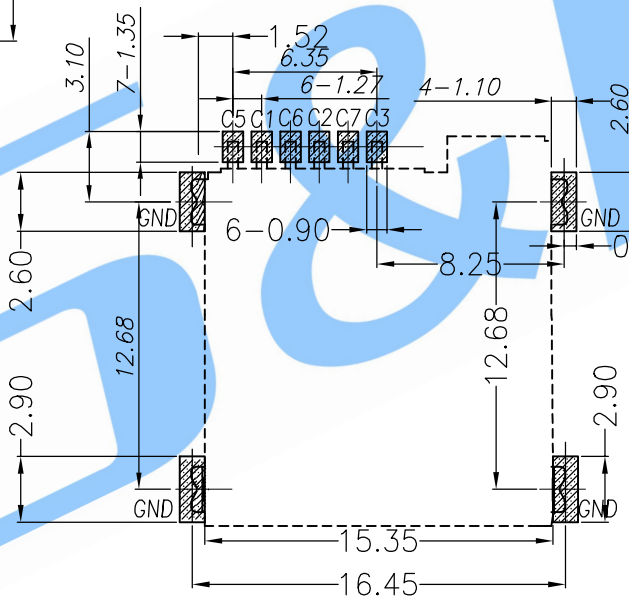








C1:VCC
C2:RST
C3:CLK
C4:RESERVED
C5:GND
C6:VPP
C7:I/O
C8:RESERVED



PCB 焊盘区

下沉避位区

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
Shell: SUS

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au 1U
Shell: Plated 50u'' Ni Overall
Plated 1u"Au Selective Contact Area

Electrical:

Current Rating :0.5mA AC/DC max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100m Ω max.
Insulation Resistance:1000M Ω min./500VDC
Mating Cycles:10,000 Insertions
产品耐温温度：260° C □C S≤1.70×□C S≤1.70×5□C -5□C
Mating Cycles:3,000-5,000 Insertions

SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.15
X.XX: ±	0.10
X.XXX: ±	0.05
ANGULAR: ±	1°

5&K ELECTRONICS CO.,LTD

PRODUCT NAME : MICRO-SIM 卡座PUSH/PUSH 1.35H-6 PIN	DRAWING: COCO	DATE: 2012/04/10	
PRODUCT NO. : SK-C793	CHECK: JANY	DATE: 2012/04/11	
DRAWING NO. :	APPROVED:	DATE: 2012/04/11	
	SCALE: 1:1	DWG ID: C D	REV.: B / PAGE: 1 OF 1

REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE

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